## **BGA Heat Sink - High Performance** maxiFLOW/superGRIP





ATS Part#: ATS-X50150P-C1-R0

Description: 15.00 x 15.00 x 17.50 mm BGA Heat Sink - High

Performance maxiFLOW/superGRIP

Heat Sink Type: maxiFLOW
Heat Sink Attachment: superGRIP

Equivalent Part Number: N/A

\*Image above is for illustration purpose only.

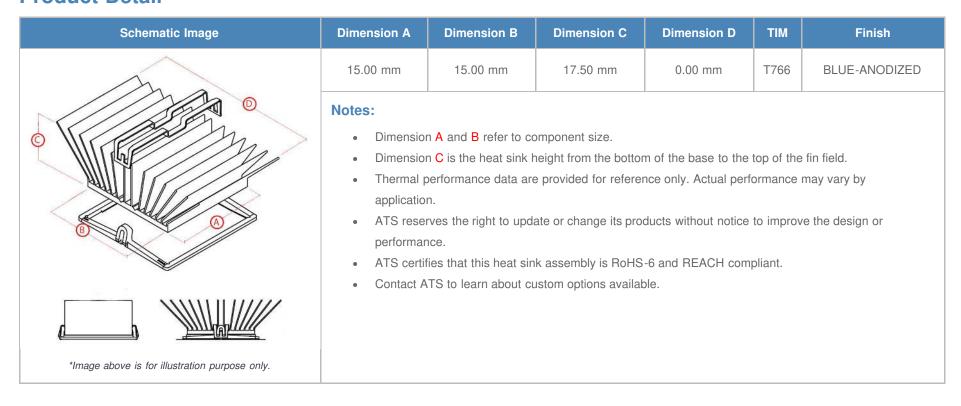
## **Features & Benefits**

- Designed for 15 x 15 mm components
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	8.7 °C/W	7.2 °C/W	6.3 °C/W	5.7 °C/W	5.2 °C/W	4.9 °C/W	4.6 °C/W
	Ducted Flow	7.1	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**







For more information, to find a distributor or to place an order, please contact us at